

#### Positive Fixed 12V Voltage Regulator in bare die form

Rev 1.1 3/11/17

#### Description

The LM2940-12 positive voltage regulator features the ability to source 1A of output current with a dropout voltage of typically 0.5V & a maximum of 1V over the entire temperature range. A quiescent current reduction circuit has been included which reduces the ground current when the differential between the input voltage & the output voltage exceeds approximately 3V. The quiescent current with 1A of output current & an input-output differential of 5V is therefore only 30 mA. Higher quiescent currents only exist when the regulator is in the dropout mode ( $V_{\text{IN}}$  -  $V_{\text{OUT}} \le 3V$ ).

#### **Ordering Information**

The following part suffixes apply:

- No suffix MIL-STD-883 /2010B Visual Inspection
- "H" MIL-STD-883 /2010B Visual Inspection
   + MIL-PRF-38534 Class H LAT
- "K" MIL-STD-883 /2010A Visual Inspection (Space)
   + MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

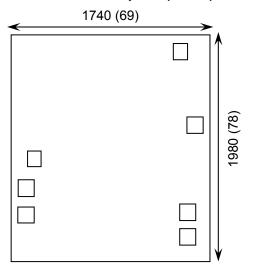
## Supply Formats:

- Default Die in Waffle Pack (100 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- Tape & Reel By specific request
- TO-3 hermetic package By specific request

#### Features:

- Dropout voltage typically 0.5V @ I<sub>O</sub> = 1A
- Output current in excess of 1A
- Reverse battery protection
- Internal short circuit current limit
- Full Military Temperature Range.

### Die Dimensions in µm (mils)



## **Mechanical Specification**

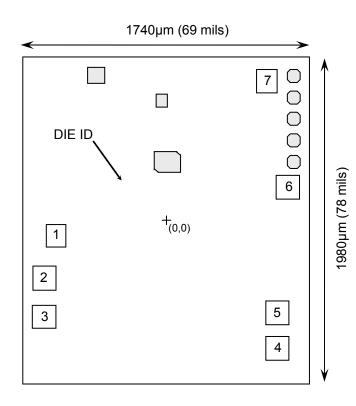
Die Size (Unsawn)	1740 x 1980 69 x 78	µm mils	
Minimum Bond Pad Size	116 x 134 4.57 x 5.28	μm mils	
Die Thickness	280 (±10) 11 (±0.4)	μm mils	
Top Metal Composition	Al 1%Si 1.1μm		
Back Metal Composition	Ti/Ni/Ag 3 μm		





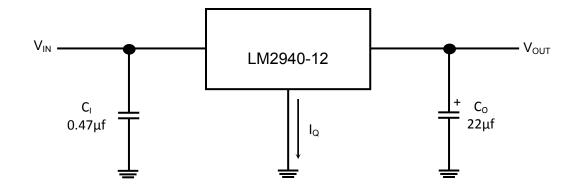
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# Pad Layout and Functions



PAD	FUNCTION	COORDINATES (µm)		
		X	Y	
1	GND	-667	-94	
2	VCC	-738.5	-352	
3	VCC	-738.5	-584	
4	OUT	675.5	-776	
5	OUT	675.5	-559	
6	OUT	739.5	201.5	
7	GND	775	877	
CONNECT CHIP BACK TO GND				

# **Typical Application**







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# **Absolute Maximum Ratings**

PARAMETER	SYMBOL	VALUE	UNIT	
Input Voltage	V <sub>IN</sub>	26	V	
Power Dissipation	P <sub>D</sub>	Internally Limited		
Operating Temperature Range	-	-55 to 125	°C	
Maximum Junction Temperature	T <sub>J</sub>	150 °C		
Storage Temperature	T <sub>STG</sub>	-65 to 150	°C	

## DC Electrical Characteristics T<sub>J</sub> = 25°C, V<sub>IN</sub> = V<sub>OUT</sub> +5V, I<sub>OUT</sub> = 1A, C<sub>O</sub> = 22µF unless otherwise specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V <sub>OUT</sub>	$16.75V \le V_{IN} \le 26V,5mA \le I_{OUT} \le 1A$	11.64	12	12.36	V
		T <sub>J</sub> = 125°C	11.40	-	12.60	
Line Regulation	ΔV <sub>OUT</sub>	$V_{OUT}$ +2V $\leq V_{IN} \leq 26V$ , $I_{OUT}$ =5mA	-	20	120	mV
		T <sub>J</sub> = 125°C	-	-	120	
Load Regulation	ΔV <sub>OUT</sub>	50mA ≤ I <sub>OUT</sub> ≤ 1A	-	55	120	
		T <sub>J</sub> = 125°C	-	-	190	
Output Impedance	R <sub>OUT</sub>	100mA DC and 20mA <sub>RMS</sub> , f <sub>O</sub> =120Hz	-	80	-	mΩ
		T <sub>J</sub> = 125°C	-	-	1000	
Quiescent Current		$V_{OUT}$ +2V $\leq$ $V_{IN}$ $\leq$ 26V, $I_{OUT}$ = 5mA	-	10	15	mA
	IQ	T <sub>J</sub> = 125°C	-	-	20	
Quiescent Current		$V_{IN} = V_{OUT} + 5V$ , $I_{OUT} = 1A$	-	30	45	mA
		T <sub>J</sub> = 125°C	-	-	60	
Output Noise Voltage	e <sub>N</sub>	10Hz-100KHz, I <sub>OUT</sub> = 5mA	-	360	-	$\mu V_{RMS}$
		T <sub>A</sub> = 125°C	-	-	1000	
Ripple Rejection	RR	$f_{O} = 120$ Hz, $1V_{RMS}$ , $I_{OUT} = 100$ mA	54	66	-	dB
		T <sub>J</sub> = 125°C	48	-	-	
Long Term Stability			-	48	-	mV/1000hr
	V <sub>D</sub>	I <sub>OUT</sub> = 1A	-	0.5	8.0	V
Dropout Voltage		T <sub>J</sub> = 125°C	-	-	1.0	
Dropout voltage		I <sub>OUT</sub> = 100mA	-	0.13	0.15	
		T <sub>J</sub> = 125°C	-	-	0.20	
Short Circuit Current	I <sub>SC</sub>	Note 1	-	2.5	-	А
Maximum Line Transient	T <sub>IN</sub>	R <sub>OUT</sub> = 100Ω, T ≤ 100ms	60	75	-	V
		$T_J$ = 125°C, $R_{OUT}$ = 100Ω, $T \le 20$ ms	40	-	-	
Reverse Polarity DC Input Voltage	$V_{RIN}$	$R_{OUT} = 100\Omega$ , $T_{J} = 25^{\circ}C$ to $125^{\circ}C$	-15	-30	-	V
Reverse Polarity Transient Input Voltage	V <sub>TRRI</sub>	R <sub>OUT</sub> = 100Ω, T ≤ 100ms	-50	-75	-	V
		$T_J$ = 125°C, $R_{OUT}$ = 100Ω, $T \le 20$ ms	-45	-	-	

Notes: 1. Output current will decrease with temperature increase but will not drop below 1A at the maximum specified temperature.





# **Typical Performance Characteristics**

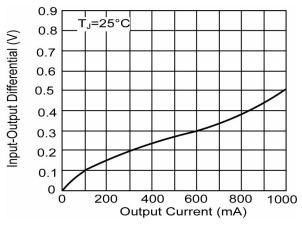


FIGURE 1. Dropout Voltage versus
Output Current

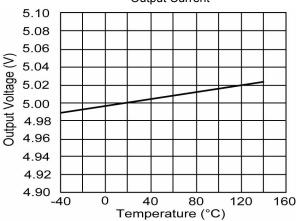


FIGURE 3. Output Voltage versus
Temperature

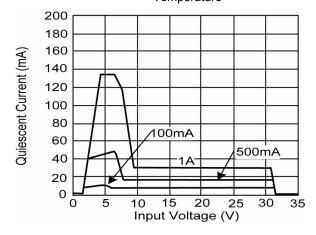


FIGURE 5. Quiescent Current versus Input Voltage

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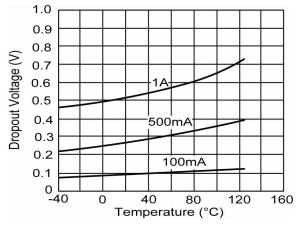


FIGURE 2. Dropout Voltage versus Temperature

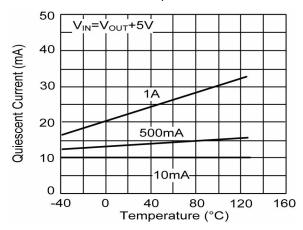


FIGURE 4. Quiescent Current versus Temperature

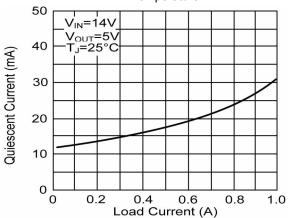


FIGURE 6. Quiescent Current versus Load Current





## Typical Performance Characteristics (Continued)

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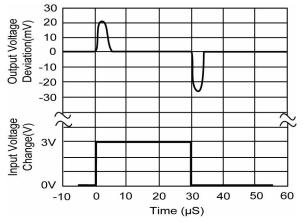
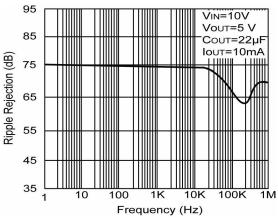


FIGURE 7. Line Transient Response



**FIGURE 9.** Ripple Rejection versus Frequency

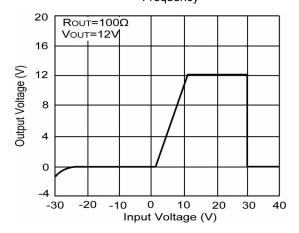


FIGURE 11. Output at Voltage extreme

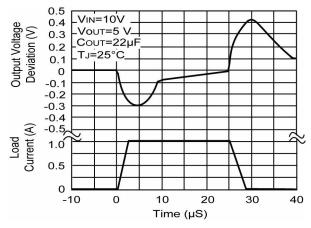


FIGURE 8. Load Transient Response

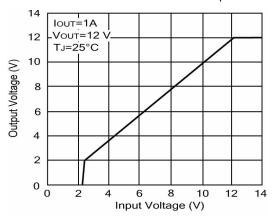


FIGURE 10. Low Voltage Behaviour

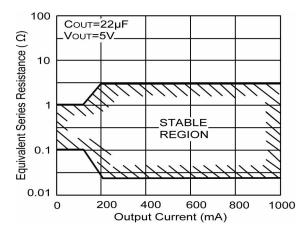


FIGURE 12. Output Capacitor ESR





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## Typical Performance Characteristics (Continued)

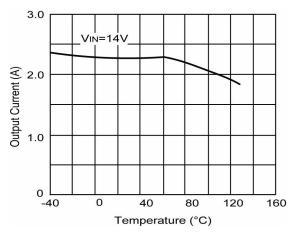


FIGURE 21. Peak Output Current

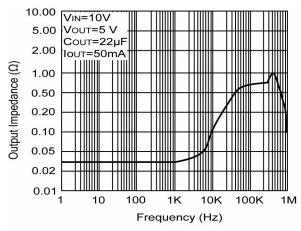


FIGURE 22. Output Impedance

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